

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Wen-Ching Chen :  
Serial No: 10/662,433 : Art Unit #2878  
Filed: 16 September 2003 : Examiner:  
Title: CHIP SCALE PACKAGE : D. Williams  
STRUCTURE FOR AN IMAGE

**AMENDMENT**

Honorable Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Official Action dated 28 July 2005, please amend the above-identified Application as follows:

**Amendments to the Claims** are reflected in the Listing of Claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 6 of this paper.